

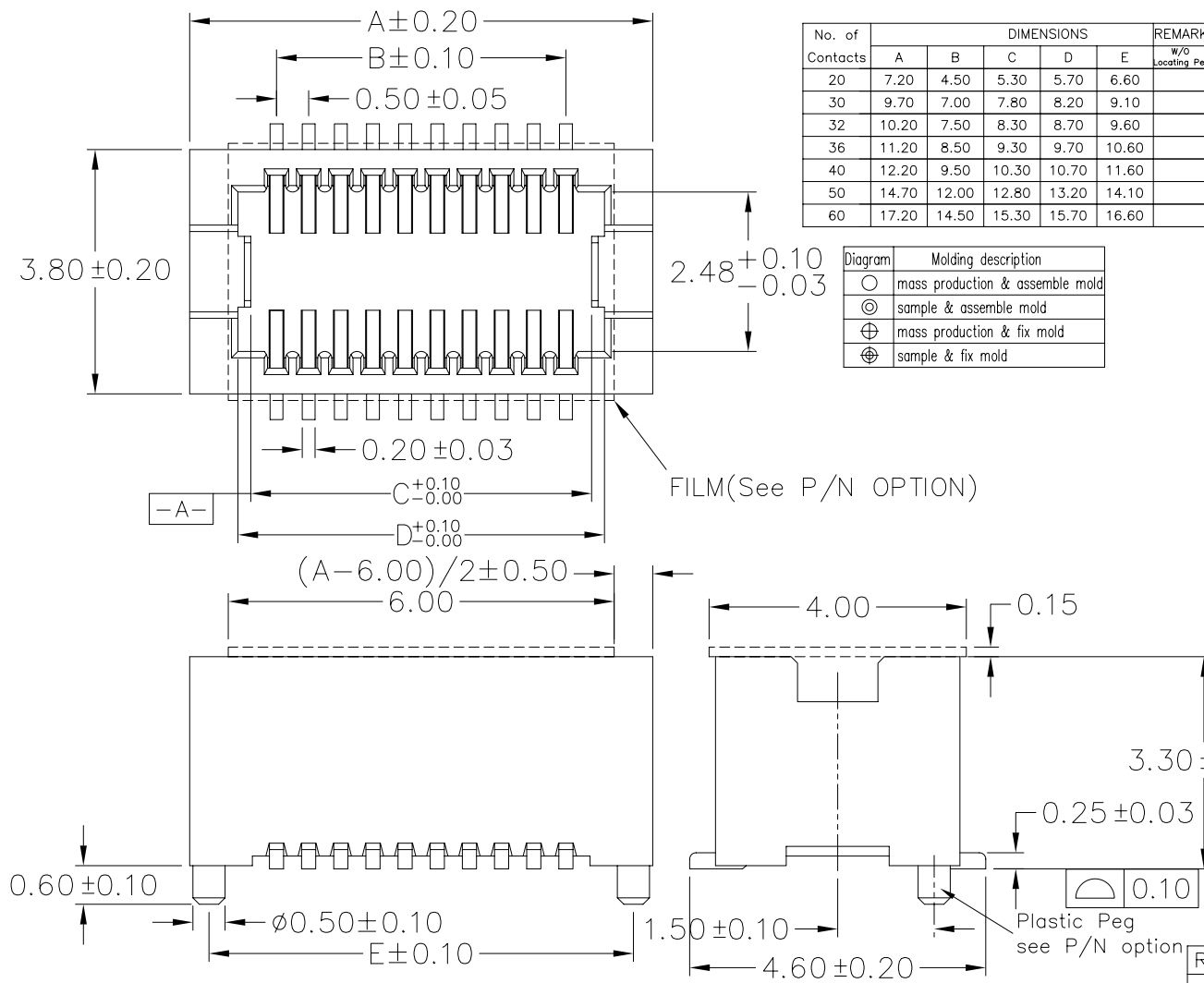
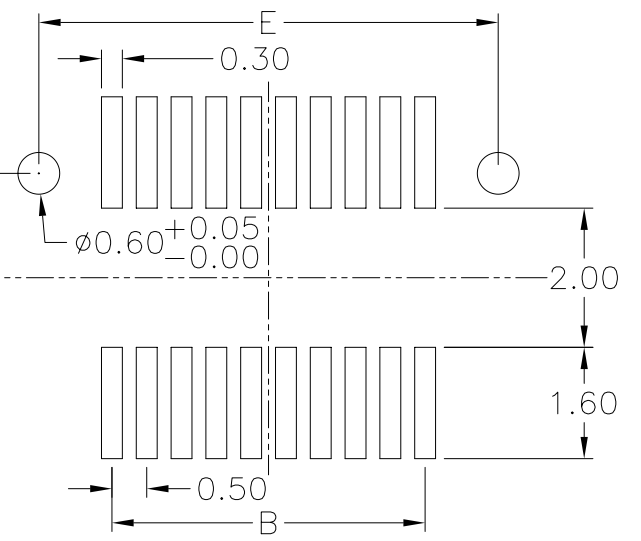
Insulator Material: High Temperature Thermoplastic, UL 94V-0
 Finish: selective Gold plated, over 50μ" Ni underplated

No. of Contacts	DIMENSIONS					REMARK W/O Locating Peg	REMARK With Locating Peg
	A	B	C	D	E		
20	7.20	4.50	5.30	5.70	6.60		⊕
30	9.70	7.00	7.80	8.20	9.10		
32	10.20	7.50	8.30	8.70	9.60		
36	11.20	8.50	9.30	9.70	10.60		⊕
40	12.20	9.50	10.30	10.70	11.60		
50	14.70	12.00	12.80	13.20	14.10		⊕
60	17.20	14.50	15.30	15.70	16.60		⊕

Diagram	Molding description
○	mass production & assemble mold
⊙	sample & assemble mold
⊕	mass production & fix mold
⊕	sample & fix mold

Definition	Code
⊕ Gold plated:	
flash B 15μ" F	
30μ" E	
⊕ Standard: B	
⊕ Prefix "V" means lead free plating.	

Recommended PCB Layout (PCB TOLERANCE ±0.05)



NOTE: HARMFUL MATERIAL SHOULD BE COMPLIANT TO Doc."EI-0005" STANDARDS.

Rev.	ECN Number	Description	Drawn	Date
4	EC2-4C0137	新增 60PIN 有導量產模	陳顯鑫	12/08/04'
5	ECR-550047 ECR-550048	工程設計變更	余小兵/陳美竹	05/16 05'
6	EC3-5B0087	新增 50PIN 有導量產模	伍沂峰/詹益東	11/28 05'



GENERAL TOLERANCE		SCALE	8=1
XX. ± 0.50	XXX. ±	UNIT	MM
X. ± 0.30	.XXX ±	SIZE	A4
.X ± 0.25	X.° ± 4°		
.XX ± 0.20	.X° ± 4°		

ORIGINAL DRAWN	DATE
邱若婷	10/09/03'
CHECK	DATE
林錫錦	11/28 05'
APPROVE	DATE
林錫錦	11/28 05'

DWG. NO.	TITLE	REV.
X-XX	0.50 pitch Board to Board socket Type	6
F: \CDWG\ZVH\ZVH0A.DWG	(成品規格圖)	SHEET
PARTS NO.	ZVH-XXS1-X-X-*	1/1